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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Byung-Hee KIM, et al.

Serial No. 10/035,257

Filed: January 4, 2002

For: Method of Fabricating Metal
Lines in a Semiconductor Device

Examiner: Maria F. Guerrero

Art Unit: 2822

Atty. Docket No. 262/014

6/A Amcl
4-17-03
A. Well

AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents
United States Patent and Trademark Office
Washington, D.C. 20231

Sir:

In response to the Office Action mailed October 4, 2002, kindly amend the subject application as follows:

IN THE SPECIFICATION:

Kindly amend the specification as follows: